



SANYO Semiconductors

DATA SHEET

LA6560

Monolithic Linear IC

For CD

Five-Channel Driver

(BTL : Four-Channel, H Bridge : One-Channel)

Overview

The LA6560 is a 5-channel driver (BTL : 4-channel, H bridge : 1-channel) for CD players.

Functions

- Power amplifier 5-channel built-in. (Bridge-connection (BTL) : 4-channel, H bridge : 1-channel)
- I_O max 1A
- Level shift circuit built-in (except H bridge).
- Mute circuit (output ON/OFF) built-in.
(Operable with BTL AMP and not operable for the H bridge of 5VREG)
- 5V regulator built-in (external PNP transistor).
- With VREF changeover function (H : external, L : internal (2.5V) selected)
- Overheat protection circuit (thermal shutdown) built-in.

Specifications

Maximum Ratings at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage	V_{CC} max		14	V
Allowable power dissipation	P_d max	Independent IC	2.0	W
		Mounted on specified board. *	0.8	W
Maximum output current	I_O max	Each output for H bridge, channel 1 to 4.	1	A
Maximum input voltage	V_{INB}		13	V
MUTE pin voltage	V_{MUTE}		13	V
Operating temperature	T_{opr}		-30 to +85	$^\circ\text{C}$
Storage temperature	T_{stg}		-55 to +150	$^\circ\text{C}$

* Specified board size : 76.1×114.3×1.6mm³, glass epoxy.

Recommended Operating Conditions at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage	V_{CC}		5.6 to 13	V

■ Any and all SANYO Semiconductor products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your SANYO Semiconductor representative nearest you before using any SANYO Semiconductor products described or contained herein in such applications.

■ SANYO Semiconductor assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all SANYO Semiconductor products described or contained herein.

SANYO Semiconductor Co., Ltd.

TOKYO OFFICE Tokyo Bldg., 1-10, 1 Chome, Ueno, Taito-ku, TOKYO, 110-8534 JAPAN

LA6560

Electrical Characteristics at $T_a = 25^\circ\text{C}$, $V_{CC1} = V_{CC2} = 8\text{V}$, $V_{REF} = 2.5\text{V}$, unless especially specified.

Parameter <small>www.DataSheet4U.com</small>	Symbol	Conditions	Ratings			Unit
			min	typ	max	
ALL Blocks						
No-load current drain ON	I_{CC-ON}	BTL-AMP output ON, LOADING block OFF *1		30	50	mA
No-load current drain OFF	I_{CC-OFF}	All outputs OFF *1		10	15	mA
Thermal shutdown temperature	TSD	Design guarantee value	150	175	200	$^\circ\text{C}$
VREF AMP						
VREF-AMP offset voltage	VREF-OFFSET		-10		10	mV
VREF Input voltage range	VREF-IN		1		$V_{CC}-1.5$	V
VREF-OUT output current	I-VREF-OUT	CH1 input reference voltage	2	5	6.6	mA
BTL AMP Block (CH1 to CH4)						
Output offset voltage	V_{OFF}	Voltage difference between outputs for BTL AMP, each channel. *2	-50		50	mV
Input voltage range	V_{IN}	Input voltage range for input for OP-AMP.	0		$V_{CC}-1.5$	mA
Output voltage	V_O	Each voltage between V_{O+} and V_{O-} when $R_L = 8\Omega$. *3	5.7	6.2		V
Closed-circuit voltage gain	VG	Input and output gain. Input OP-AMP:BUFFER	3.6	4	4.4	Times
Slew rate	SR	AMP Independent Multiply 2 between outputs.		0.5		V/ μs
MUTE ON voltage	VMUTE-ON	Output ON voltage, each MUTE *4	2			V
MUTE OFF voltage	VMUTE-OFF	Output OFF voltage, each MUTE *4			0.5	V
Input AMP Block (CH1 to 4)						
Input voltage range	V_{IN-OP}		0		$V_{CC}-1.5$	V
Output current (SINK)	SINK-OP		2			mA
Output current (SOURCE)	SOURCE-OP	*5	300	500		μA
Output offset voltage	V_{OFF-OP}		-10		10	mV
CH1 input changeover voltage 1	VSW-OP1	CH1 input AMP(B), external VREF select *6	2			V
CH1 input changeover voltage 2	VSW-OP2	CH1 input AMP(A), internal VREF select *6			0.5	V
Loading Block (CH5, H bridge)						
Output voltage	V_{O-LOAD}	At forward and reverse rotation, $R_L = 8\Omega$, $V_{CONT}=V_{CC}$ *3	5.7	6.5		V
Break output saturation voltage	$V_{CE-BREAK}$	Output voltage at braking *7			0.3	V
Input low level	V_{IN-L}				1	V
Input high level	V_{IN-H}		2			V
Power Supply Block (PNP transistor : 2SB632K-use)						
5V supply voltage	V_{OUT}	$I_O = 200\text{mA}$	4.8	5.0	5.2	V
REG-IN SINK current	REG-IN-SINK	Base current of external PNP *8	5	10		mA
Line regulation	ΔV_{OLN}	$6\text{V} \leq V_{CC} \leq 12\text{V}$, $I_O = 200\text{mA}$		10	100	mV
Load regulation	ΔV_{OLD}	$5\text{mA} \leq I_O \leq 200\text{mA}$		10	100	mV

Note *1 : Current dissipation that is a sum of V_{CC1} and V_{CC2} at no load.

*2 : Input AMP is a BUFFER AMP.

*3 : Voltage difference between both ends of load (8Ω). Output saturated.

*4 : Output ON with MUTE : [H] and OFF with MUTE : [L] (HI impedance).

*5 : The source of input OP-AMP is a constant current. As the $11\text{k}\Omega$ resistance to the next stage is a load, pay due attention when setting the input OP-AMP gain.

*6 : With V_{IN1-SW} : [L], the input AMP selects AMP-A while VREF selects internal VREF ($\approx 2.5\text{V}$).

With V_{IN1-SW} : [H], the input AMP selects AMP-B while VREF selects external VREF ($\approx V_{REF-IN}$).

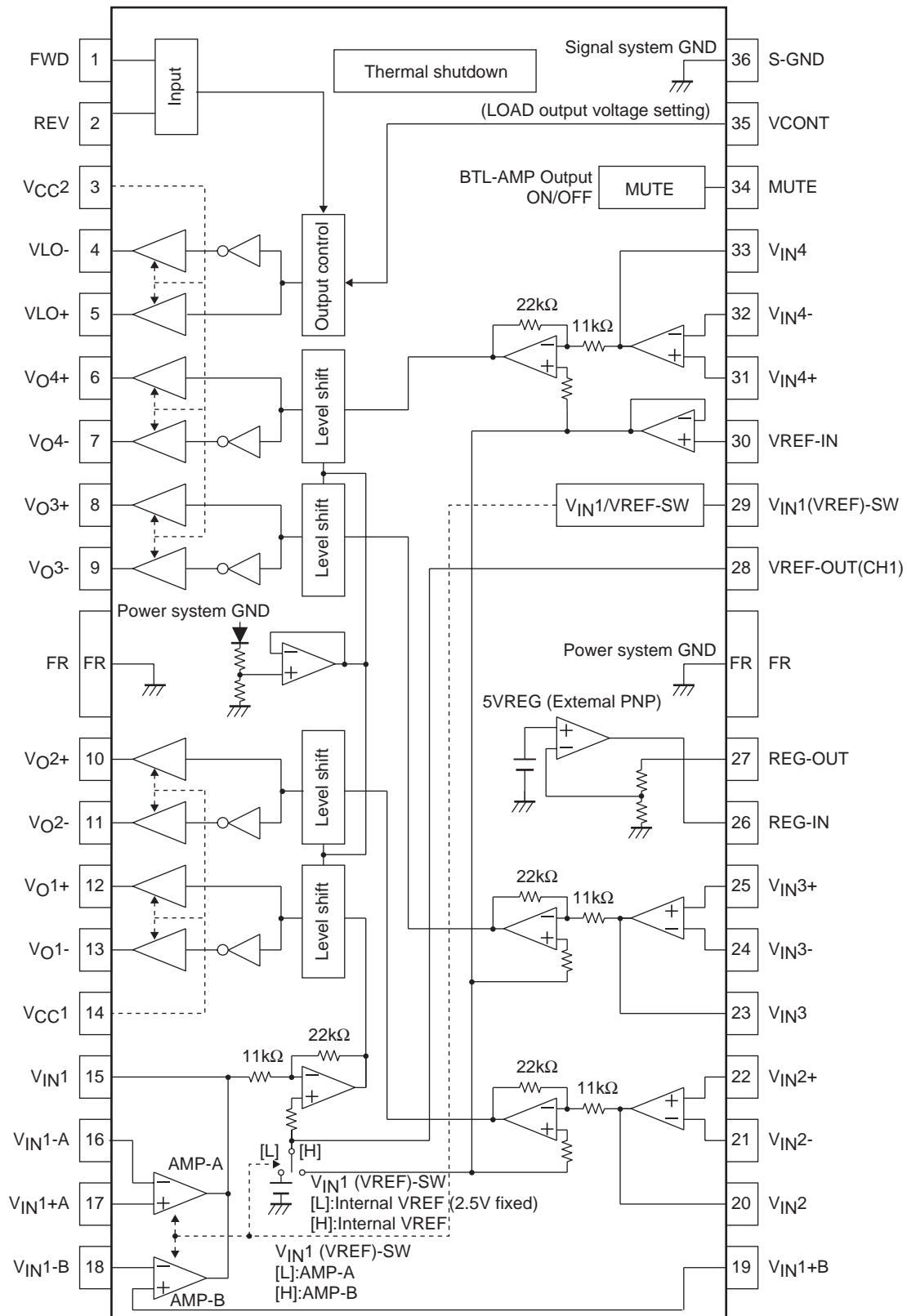
*7 : Short (GND) brake used. SINK side output ON.

*8 : 5VREG incorporates a drooping protection circuit and operated when the base current is 10mA (TYP).

LA6560

Block Diagram

www.DataSheet4U.com



LA6560

Pin Functions

Pin No.	Symbol	Pin descriptions
1	FWD	Output change pin (FWD) for 5CH (VLO), logic input for loading block.
2	REV	Output change pin (REV) for 5CH (VLO), logic input for loading block.
3	V _{CC2}	Power supply for CH3, 4, and 5.
4	VLO-	Loading output (-)
5	VLO+	Loading output (+)
6	V _{O4+}	Output pin (+) for channel 4
7	V _{O4-}	Output pin (-) for channel 4
8	V _{O3+}	Output pin (+) for channel 3
9	V _{O3-}	Output pin (-) for channel 3
10	V _{O2+}	Output pin (+) for channel 2
11	V _{O2-}	Output pin (-) for channel 2
12	V _{O1+}	Output pin (+) for channel 1
13	V _{O1-}	Output pin (-) for channel 1
14	V _{CC1}	Power supply for CH1, 2 (BTL).
15	V _{IN1}	Input pin for channel 1
16	V _{IN1-A}	OP-AMP input AMP-A input pin (-)
17	V _{IN1+A}	OP-AMP input AMP-A input pin (+)
18	V _{IN1-B}	Input AMP-B input pin (-) for channel 1
19	V _{IN1+B}	Input AMP-B input pin (+) for channel 1
20	V _{IN2}	Input pin for channel 2, input AMP output
21	V _{IN2-}	Input pin (-) for channel 2
22	V _{IN2+}	Input pin (+) for channel 2
23	V _{IN3}	Input pin for channel 3, input AMP output
24	V _{IN3-}	Input pin (-) for channel 3
25	V _{IN3+}	Input pin (+) for channel 3
26	REG-IN	PNP transistor base connected
27	REG-OUT	5V power output to which the PNP transistor collector connected.
28	VREF-OUT	CH1 reference voltage output. Outputs internal VREF (2.5V : TYP) or external VREF.
29	V _{IN1} (VREF) -SW	Pin for changeover between input AMP-A/internal VREF (TYP2.5V) and input AMP-B/ external VREF.
30	VREF-IN	Reference voltage applied pin
31	V _{IN4+}	Input pin (+) for channel 4
32	V _{IN4-}	Input pin (-) for channel 4
33	V _{IN4}	Input pin for channel 4, input AMP output
34	MUTE	All BTL AMP output ON/OFF
35	VCONT	LOADING output voltage setting
36	S-GND	Signal system GND

Note : Center frame (FR) becomes GND for the power system (P-GND). Set this to the minimum potential together with S-GND.

LA6560

Pin Description

Pin No.	Symbol	Pin function	Description	Equivalent circuit
17 19 16 18 15 22 21 20 25 24 23 32 31 33	V_{IN1+A} V_{IN1+B} V_{IN1-A} V_{IN1-B} V_{IN1} V_{IN2+} V_{IN2-} V_{IN2} V_{IN3+} V_{IN3-} V_{IN3} V_{IN4-} V_{IN4+} V_{IN4}	Input (CH1 to 4)	Input pin (CH1 to 4)	
1 2	FWD REV	Input (H bridge)	Logic input pin. By combining H and L of this pin, any one of four modes (forward/reversed/brake/idling) can be selected.	
12 13 10 11 8 9 6 7	V_{O1+} V_{O1-} V_{O2+} V_{O2-} V_{O3+} V_{O3-} V_{O4+} V_{O4-}	Output (BTL-AMP)	Output for channel 1 to 4.	
4 5 35	V_{LO-} V_{LO+} VCONT	Output (H bridge)	H bridge (LOADING) output and LOADING output setting pin	
34	MUTE	MUTE	BTL AMP output, which turns ON/OFF the output, MUTE : H Output OFF MUTE : L Output OFF	

LA6560

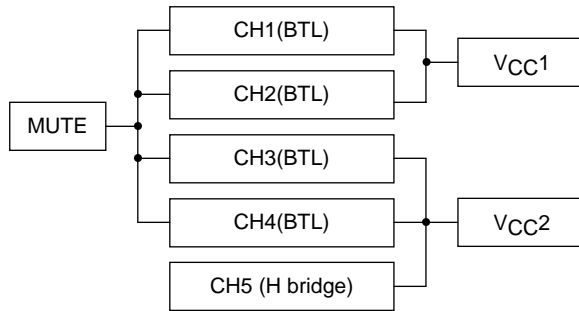
Truth Table (loading (H bridge) section)

FWD	REV	VLO+	VLO-	Loading output
L	L	OFF	OFF	OFF *1
	H	H	L	Forward
H	L	L	H	Reversed
	H	L	L	(Short) brake *2

*1 The output has a high impedance.

*2 At brake, the SINK side transistor is ON (short brake).
VLO+ and VLO- are approximately on the GND level.

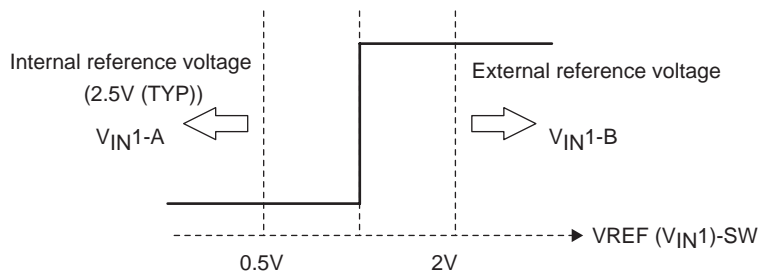
Relation of MUTE and Power (VCC*)



V_{IN1} (VREF)-SW (CH1 input AMP selection and internal/external VREF selection function)

(Relation between input AMP (CH1 only) and VREF)

V _{IN1} _SW	Input AMP (CH1) state	VREF state
H	V _{IN1} -A (AMP-A)	Internal VREF (2.5V : TYP)
L	V _{IN1} -B (AMP-B)	External VREF



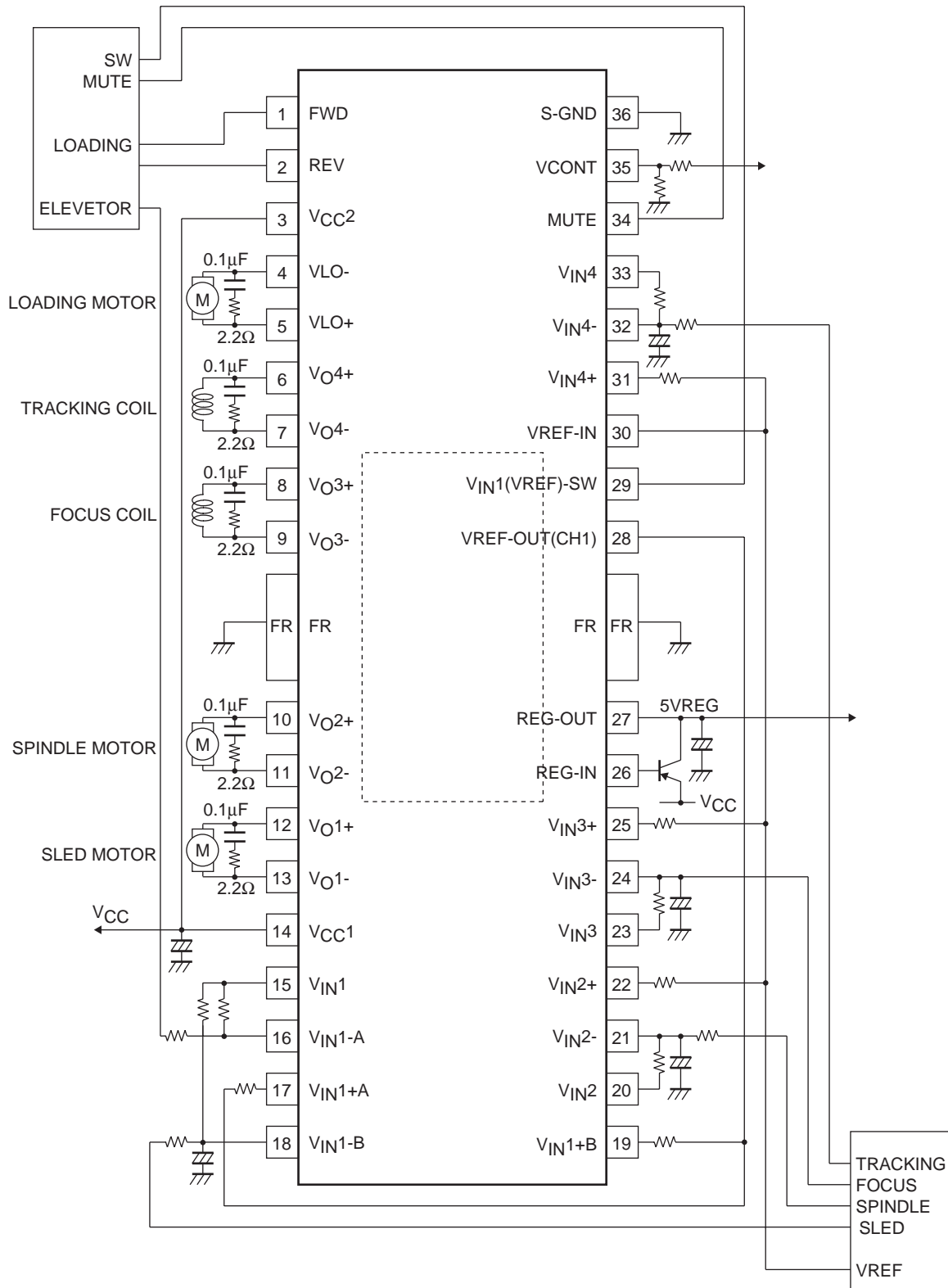
On MUTE

MUTE	BTLAMP output	VREF-OUT
L	OFF	
H	ON	

VREF-OUT operates in an interlock with MUTE.

Sample Application Circuit

www.DataSheet4U.com



- Specifications of any and all SANYO Semiconductor products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- SANYO Semiconductor Co., Ltd. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all SANYO Semiconductor products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of SANYO Semiconductor Co., Ltd.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the SANYO Semiconductor product that you intend to use.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. SANYO Semiconductor believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

This catalog provides information as of December, 2006. Specifications and information herein are subject to change without notice.